

XL-2520SURC/T

技术数据表 Technical Data Sheet

2520 红光 直插小蝴蝶

特点 (characteristic) :

- * 外观尺寸 (L/W/H) :2.1*2.3*2.6*Ø1.8mm
Appearance dimension (L / w / h): 2.1*2.3*2.6*Ø1.8mm
- * 发光颜色及胶体: 红色/透明胶体
Luminous color and colloid: Red Light /Water colloid
- * 环保产品, 符合ROHS要求
Environmental protection products meet ROHS requirements
- * 湿气敏感性等级 (MSL) :2级
Moisture sensitivity level (MSL) : 2 levels
- * EIA规范标准包装
EIA standard packaging
- * 使用寿命长
Long operating life
- * 降低维护成本
Reduced maintenance costs
- * 高能效、启动快
High energy efficiency, fast startup



模型图仅供参考

应用领域 (product application)

- * 仪表板、刹车灯、转向灯
Automotive: Dashboards, stop lamps, turn signals.
- * 数码电子游戏机
Digital electronic game console
- * 各类医疗和工业设备按钮指示
Indication of various medical and industrial equipment buttons
- * 消费和工业电子状态指示
Status indicators: Consumer & industrial electronics.
- * 背光: 液晶显示器, 键盘广告
Backlight: LCD, Key pads advertising.
- * 3C数码(键盘、电脑主机箱)指示灯
3c digital (keyboard, computer main unit box) indicator light



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电性参数

Electrical Characteristics

极限参数 (Absolute Maximum Ratings) (Ta=25°C)

项目参数 Parameter	符号 Symbol	数值 Value	单位Unit
最大功耗 (Max Power Dissipation)	PD	50	mW
最大正向电流 (Max Continuous Forward Current)	IF	20	mA
最大脉冲峰值电流 (Peak Forward Current)	IFP	80	mA
最大反向电压 (Max Reverse Voltage)	VR	5	V
抗静电能力 (Antistatic ability)	ESD	2000	V
工作环境 (Operating Temperature Range)	TOPR	-20 ~ +85 °C	°C
储存温度 (Storage Temperature Range)	TSTR	-40 ~ +85 °C	°C
焊接条件 Welding conditions	Tsol	波峰焊 (reflow soldering) : 240°C, ≤6s 手动焊 (manual welding) : 300°C, 3s 焊接点离胶体底部在2.0mm以上	

光电参数 (Initial Electrical Optical Characteristics) (Ta=25°C)

项目参数 Parameter	符号 Symbol	最小值 Min.	一般值 Typ.	最大值 Max.	单位 Unit	测试条件 Test conditions
发光强度 (Luminous Intensity)	Iv	1500	/	3000	mcd	IF=20mA
主波长 (Dominant Wave Length)	λ d	615	/	630	nm	IF=20mA
峰值波长 (Peak Wave Length)	λ p	/	625	/	nm	IF=20mA
正向电压 (Forward Voltage)	VF	1.8	/	2.4	V	IF=20mA
半波宽 (Half wave width)	Δλ	/	20	/	nm	IF=20mA
发光角度 (Viewing Angle)	2θ1/2	/	20°	/	deg	IF=20mA
反向电流 (Reverse Current)	IR	/	/	≤5	μ A	VR=5V

亮度分档:

Brightness grading:

代码 Code	最小值 Min	最大值 Max	单位 Unit	测试条件 Test conditions
B1	1500	1800	mcd	IF=20mA
B2	1800	2100		
B3	2100	2500		
B4	2500	3000		

电压分档:

Voltage grading:

代码 Code	最小值 Min	最大值 Max	单位 Unit	测试条件 Test conditions
N12-7	1.8	2.0	V	IF=20mA
N12-8	2.0	2.2		
N12-9	2.2	2.4		

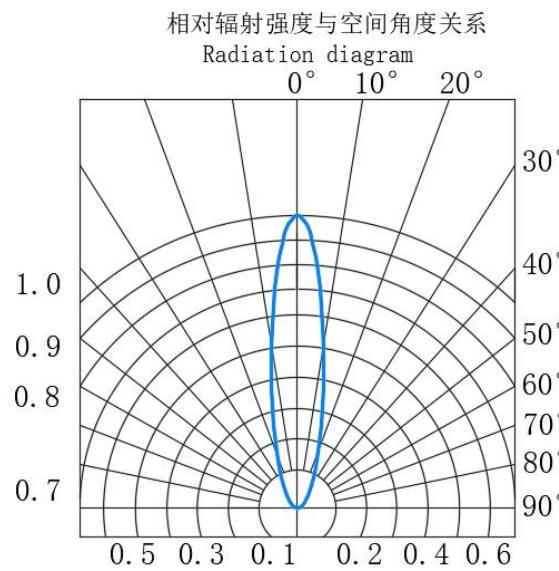
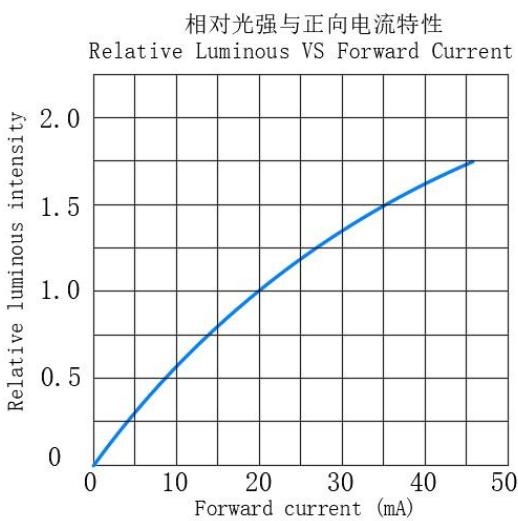
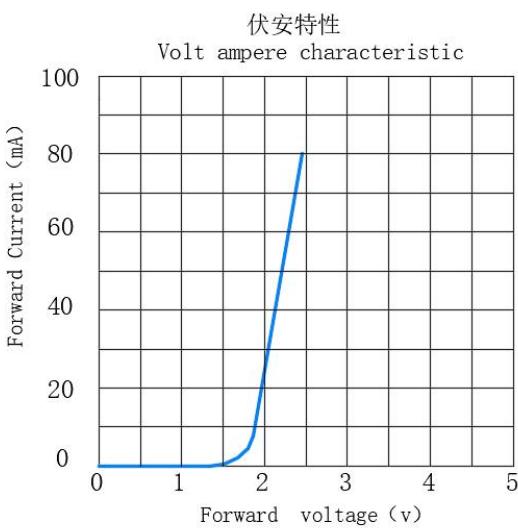
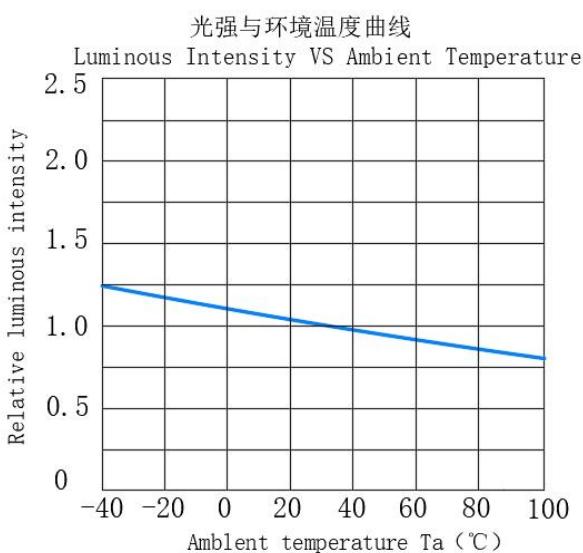
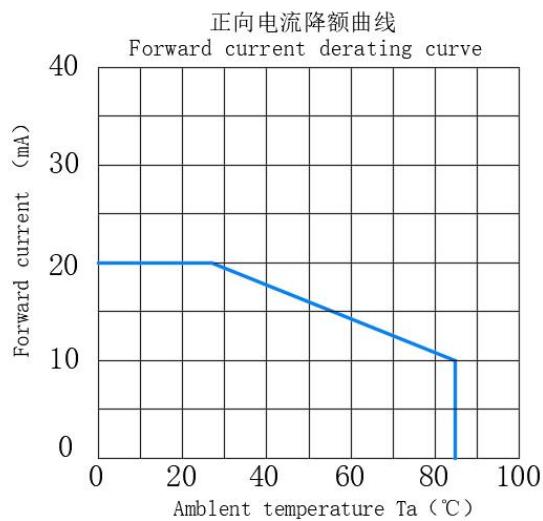
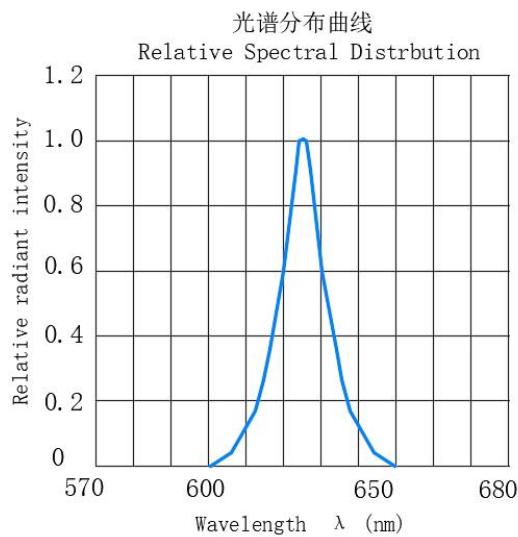
波长分档:

Wavelength grading:

代码 Code	最小值 Min	最大值 Max	单位 Unit	测试条件 Test conditions
HR01	615	620	nm	IF=20mA
HR02	620	625		
HR03	625	630		

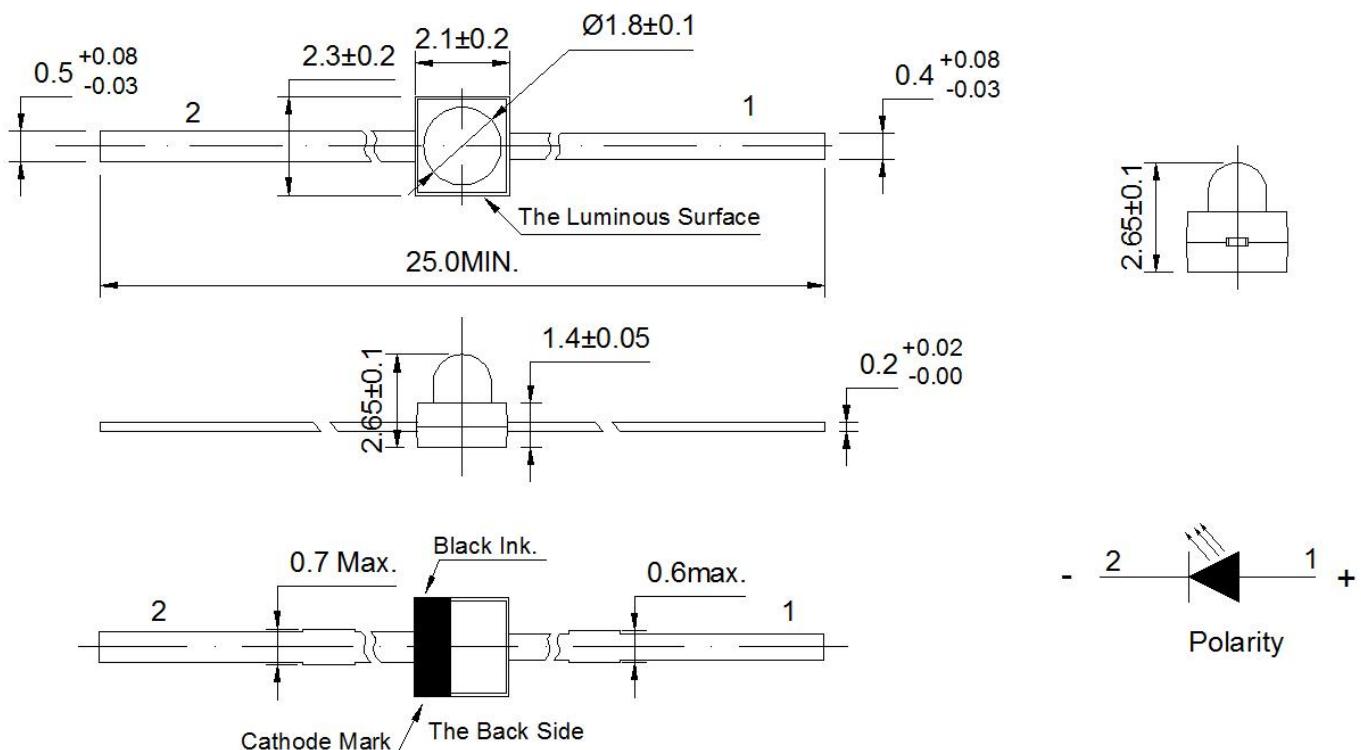
典型特性曲线

Typical Characteristics Curves



外形尺寸

Outline Dimension



备注(Note):

- 标注尺寸单位为毫米
Dimensions are in millimeters.
- 除特别标注外，所有尺寸允许公差± 0.10mm .
Tolerances unless mentioned are ± 0.10mm.

包装

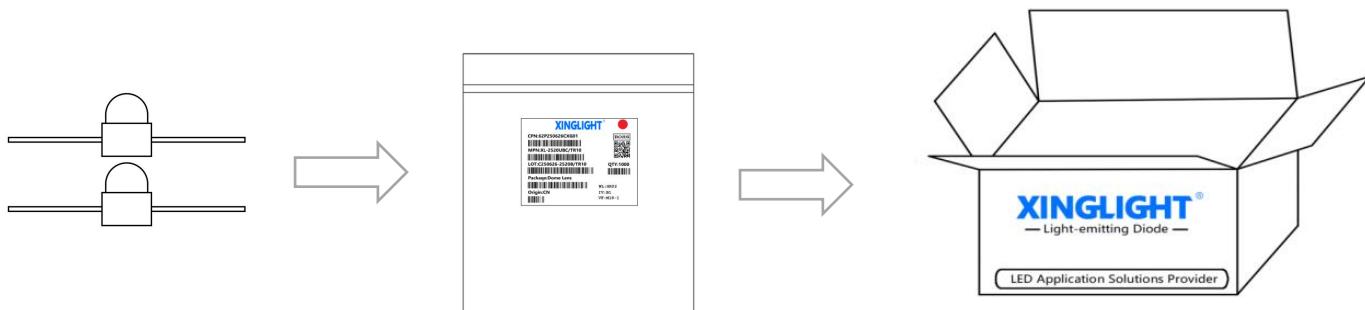
Packaging

*袋装

In Bags

*防潮抗静电包装

Moisture Proof and Anti-Electrostatic Foil Bag



◇ 标签说明 Label Expansion

CPN: 批号/档位

LOT: 日期/封装颜色

MPN: 型号

VF: 电压代码

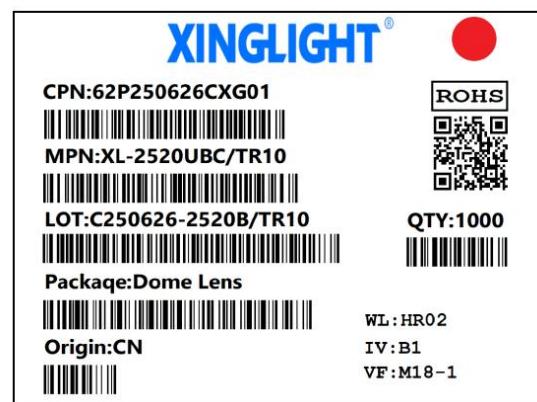
WL: 波长代码

IV: 亮度代码

ORIGIN: 产地

QTY: 数量

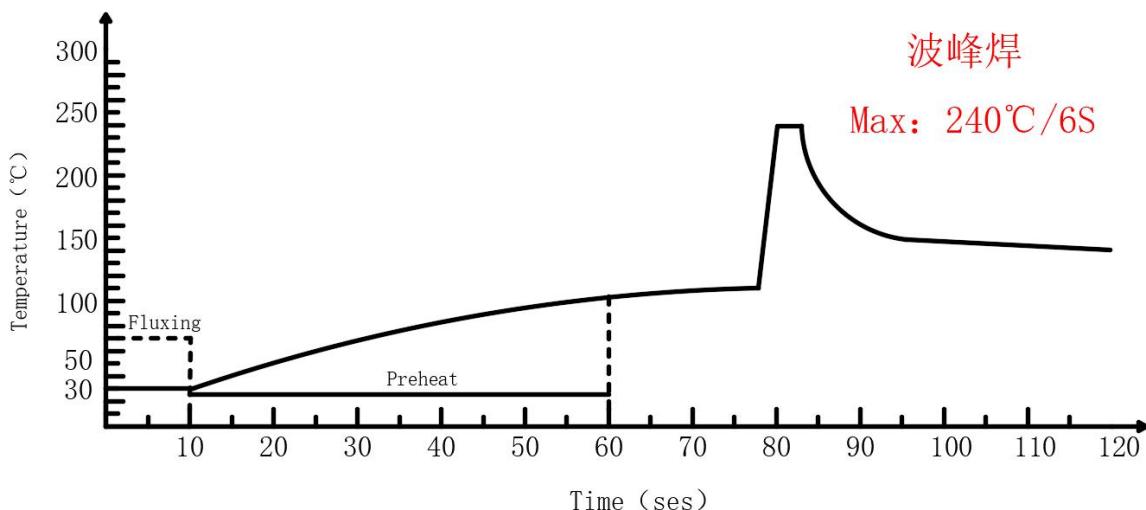
PACKAQE: 封装



焊接指导

Guideline for Soldering

推荐焊接温度曲线 The wave peak welding curve is recommended :



注意: Note

1 、铅焊料温度剖面

Lead solder temperature profile

2 、波峰焊焊接次数建议一遍

Suggest one wave soldering frequency

3 、焊接时, 不要在加热过程中对 LED 施加压力

When soldering, do not put stress on the LED during heating

4 、焊接后, 不要使电路板翘曲

After soldering, do not warp the circuit board

5 、产品最佳的最高焊接温度建议控制在240°C/6S

The recommended maximum welding temperature for the product is 240 °C/6s

使用注意事项 (1)

Precautions (1)

1. 贮存:

Storage

- 本产品使用密封防潮抗静电袋包装，并附有干燥剂，未开封的产品有一年的保存时间。

Moisture proof and anti-electrostatic package with moisture absorbent material is used, to keep moisture to a minimum.

- 开封前，产品须存放在温度不高于 30°C，湿度不高于 60%RH 的环境中。

Before opening the package, the product should be kept at 30°C or less and humidity less than 60% RH, and be used within a year.

- 开封后，产品须存放在温度不高于 30°C，湿度不高于 40%RH 的环境中，且应该在 168 小时 (7 天) 内使用完。建议工作环境为温度不高于 30°C，湿度不高于 60%RH。

After opening the package, the product should be stored at 30°C or less and humidity less than 40%RH, and be soldered within 168 hours (7 days). It is recommended that the product be operated at the workshop condition of 30°C or less and humidity less than 60%RH.

- 对于尚未焊接的 LED，如果吸湿剂或包装失效，或者产品没有符合以上有效存储条件，烘焙可以起到一定的性能恢复效果。烘焙条件: 60 ± 5 °C，持续24 小时。

If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed based on the following condition: (60 ± 5) °C for 24 hours.

2. 静电:

Static Electricity

静电和电涌会导致产品特性发生改变，例如正向电压降低等，如果情况严重甚至会损毁产品。所以在使用时必须采取有效的防静电措施。所有相关的设备和机器都应该正确接地，同时必须采取其他防止静电和电涌的措施。使用防静电手环，防静电垫子，防静电工作服、工作鞋、手套，防静电容器，都是有效的防止静电和电涌的措施。

Static electricity or surge voltage damages the LEDs. Damaged LEDs will show some unusual characteristic such as the forward voltage becomes lower, or the LEDs do not light at the low current. even not light.

All devices, equipment and machinery must be properly grounded. At the same time, it is recommended that wrist bands or anti-electrostatic gloves, anti-electrostatic containers be used when dealing with the LEDs.

使用注意事项 (2)

Precautions (2)

3、设计建议：

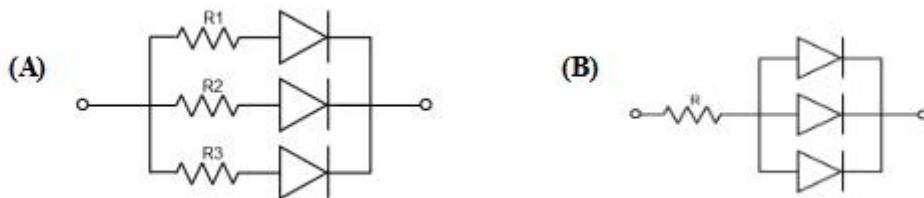
Design Consideration

* 设计电路时，通过LED的电流不能超过规定的最大值，同时，还需使用保护电阻，否则，微小的电压变化将会引起较大的电流变化，可能导致产品损毁。

建议使用以下 (A) 电路，该电路能够很好的调节通过每个 LED 的电流；不推荐使用 (B) 电路，该电路 在持续的电压驱动下，LED 的正向电压 (V_F) 发生变化，电流会随之而发生变化，可能使某些 LED 承受高于规定的电流值。

* In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LED. In the meanwhile, resistors for protection should be applied, otherwise slight voltage shift will cause big current change, burn out may happen.

It is recommended to use Circuit A which regulates the current flowing through each LED rather than Circuit B. When driving LEDs with a constant voltage in Circuit B, the current through the LEDs may vary due to the variation in Forward Voltage (V_F) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the Absolute Maximum Rating.



* LED 的特性容易因为自身的发热和环境的温度的改变而发生改变。温度的升高会降低 LED 的发光效率、影响发光颜色等，所以在设计时应充分考虑散热的问题。

* Thermal Design is paramount importance because heat generation may result in the Characteristics decline, such as brightness decreased, Color changed and so on. Please consider the heat generation of the LEDs when making the system design.

使用注意事项 (3)

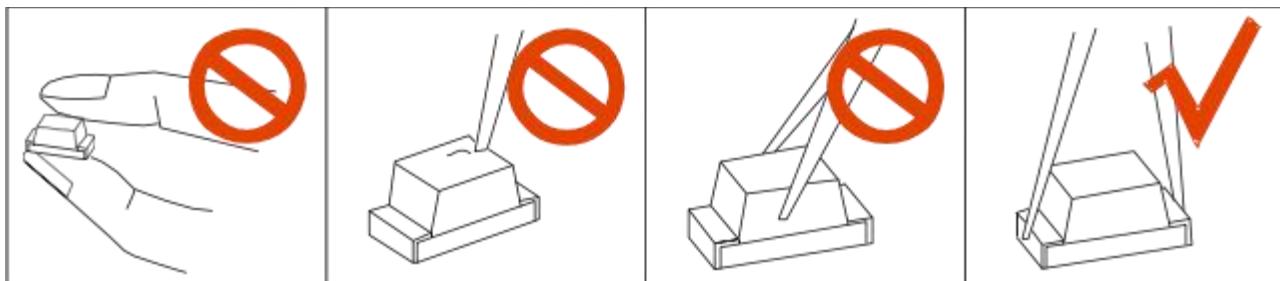
Precautions (3)

4、其他事项:

Others:

*直接用手拿取产品不但会污染封装树脂表面，也可能由于静电等因素导致产品性能的改变。过度的压力也可能直接影响封装内部的管芯和金线，因此请勿对产品施加过度压力，特别当产品处于高温状态下，例如在回流焊接过程中。

*When handling the product, touching the encapsulant with bare hands will not only contaminate its surface, but also affect on its optical characteristics. Excessive force to the encapsulant might result in catastrophic failure of the LEDs due to die breakage or wire deformation. For this reason, please do not put excessive stress on LEDs, especially when the LEDs are heated such as during Reflow Soldering.



*LED 的环氧树脂封装部分相当脆弱，请勿用坚硬、尖锐的物体刮、擦封装树脂部分。在用镊子夹取的时候也应当小心注意。

*The epoxy resin of encapsulant is fragile, so please avoid scratch or friction over the epoxy resin surface. While handling the product with tweezers, do not hold by the epoxy resin, be careful.

5、眼睛保护忠告:

Safety Advice For Human Eyes

*LED 发光时，请勿直视发光光源，特别是对于一些光强较高的 LED，强光可能伤害你的眼睛。

*Viewing direct to the light emitting center of the LEDs, especially those of great Luminous Intensity, will cause great hazard to human eyes. Please be careful.

规格书如有修改，不另行通知

If there are any modifications to the specification sheet, no further notice will be given